

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak repetitive off-state voltage⁽¹⁾ (T _J = -40 to +125°C, sine wave, 50 to 60Hz, gate open) MAC15D MAC15M MAC15N	V _{DRM}	400 600 800	Volts
RMS on-state current (60Hz, T _C = 80°C)	I _{T(RMS)}	15	Amps
Peak non-repetitive surge current (1 cycle, 60 Hz, T _J = 125°C)	I _{TSM}	150	Amps
Circuit fusing considerations (t = 8.3ms)	I ² t	93	A ² s
Peak gate power (T _C = 80°C, pulse width ≤ 1μs)	P _{GM}	20	Watts
Average gate power (T _C = 80°C, t = 8.3ms)	P _{G(AV)}	0.5	Watts
Operating junction temperature range	T _J	-40 to +125	°C
Storage temperature range	T _{stg}	-40 to +150	°C

Note 1: V_{DRM} for all types can be applied on a continuous basis. Blocking voltage shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Maximum	Unit
Thermal resistance, junction to case	R _{θJC}	2.0	°C/W
Thermal resistance, junction to ambient	R _{θJA}	62.5	°C/W
Maximum lead temperature for soldering purposes 1/8" from case for 10 seconds	T _L	260	°C

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

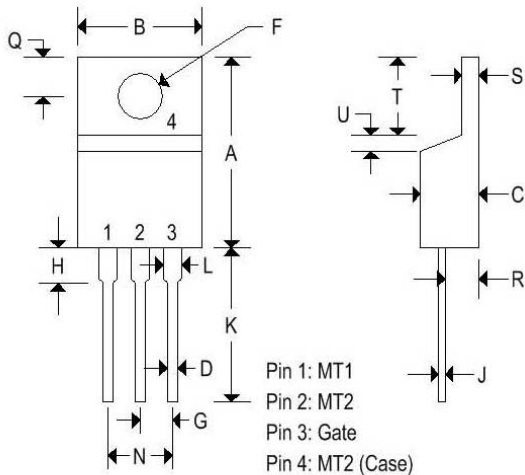
Characteristic	Symbol	Min	Typ.	Max	Unit
Peak blocking current (V _D = Rated V _{DRM} , gate open @ T _J = 25°C) (V _D = Rated V _{DRM} , gate open @ T _J = 125°C)	I _{DRM}	-	-	0.01 2.0	mA
Peak on-state voltage⁽²⁾ (I _{TM} = ±21A peak)	V _{TM}	-	1.2	1.6	Volts
Gate trigger current (continuous dc) (V _D = 12V, R _L = 100Ω) MT2(+),G(+) MT2(+),G(-) MT2(-),G(-)	I _{GT}	5.0 5.0 5.0	13 16 18	35 35 35	mA
Holding current (V _D = 12V, gate open, I _T = ±150mA)	I _H	-	20	40	mA
Latch current (V _D = 24V, I _G = 35mA) MT2(+),G(+)	I _L	-	33	50	mA

MT2(+),G(-) MT2(-),G(-)		- -	36 33	80 50	
Gate trigger voltage (continuous dc) ($V_D = 12V$, $R_L = 100\Omega$) MT2(+),G(+) MT2(+),G(-) MT2(-),G(-)	V_{GT}	0.5 0.5 0.5	0.75 0.72 0.82	1.5 1.5 1.5	Volts
Rate of change of commutating current ⁽²⁾ ($V_D = 400V$, $I_{TM} = 6A$, commutating $dv/dt = 24V/\mu s$, gate open, $T_J = 125^\circ C$, $f = 250Hz$, $C_L = 10\mu F$, $L_L = 40mH$, no snubber)	$di/dt(c)$	9.0	-	-	A/ms
Critical rate of rise of off-state voltage ($V_D = \text{Rated } V_{DRM}$, exponential waveform, gate open, $T_J = 125^\circ C$)	dv/dt	250	-	-	V/ μs

Note 2: Pulse test: Pulse width $\leq 2.0ms$, duty cycle $\leq 2\%$.

MECHANICAL CHARACTERISTICS

Case	TO-220AB
Marking	Alpha-numeric
Pin out	See below



	TO-220AB			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.575	0.620	14.600	15.750
B	0.380	0.405	9.650	10.290
C	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
H	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
N	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
T	0.235	0.255	5.970	6.480
U	-	0.050	-	1.270
V	0.045	-	1.140	-
Z	-	0.080	-	2.030

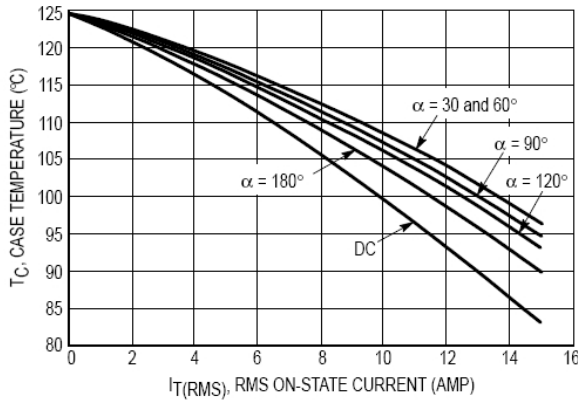


Figure 1. RMS Current Derating

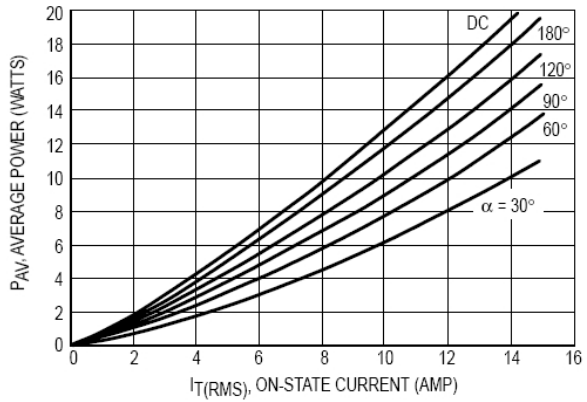


Figure 2. On-State Power Dissipation

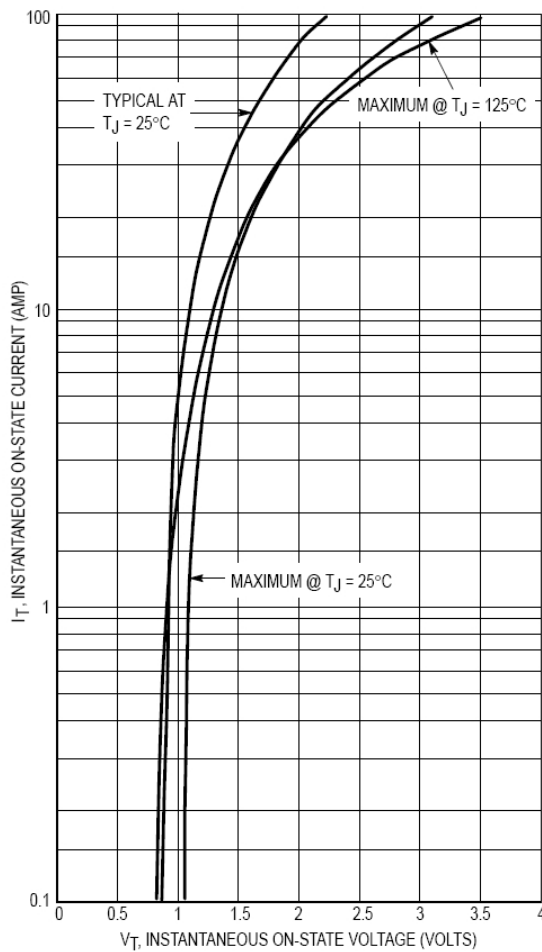


Figure 3. On-State Characteristics

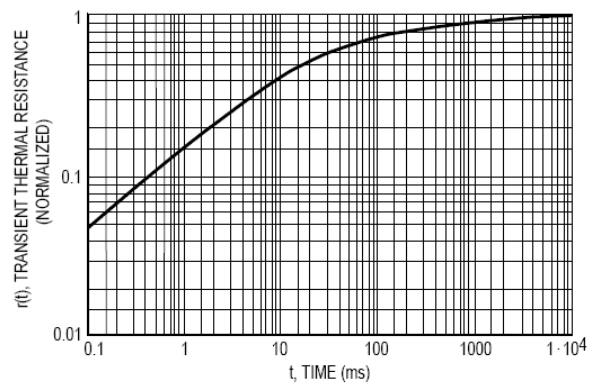


Figure 4. Thermal Response

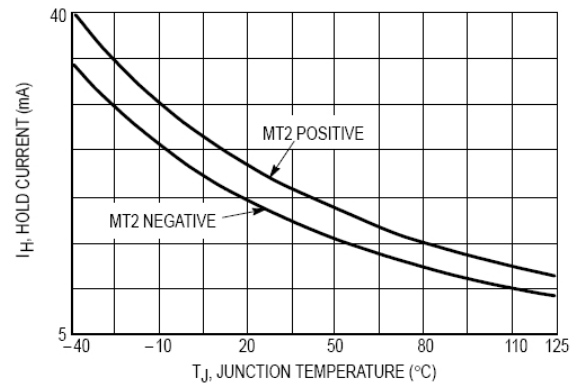


Figure 5. Hold Current Variation

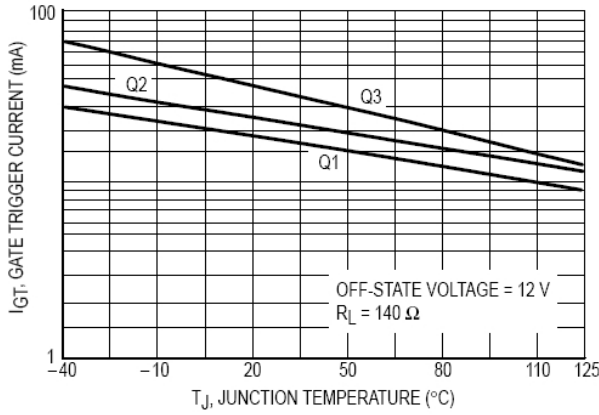


Figure 6. Gate Trigger Current Variation

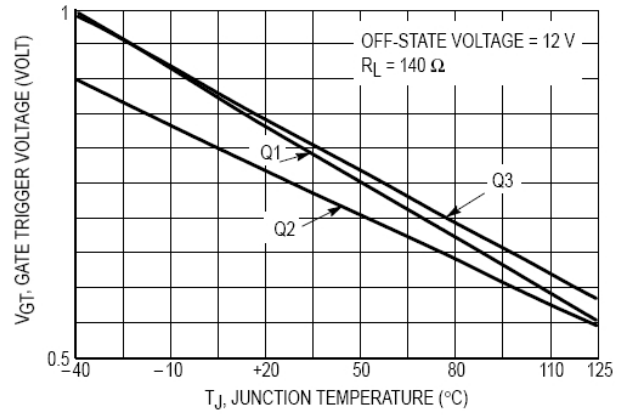


Figure 7. Gate Trigger Voltage Variation

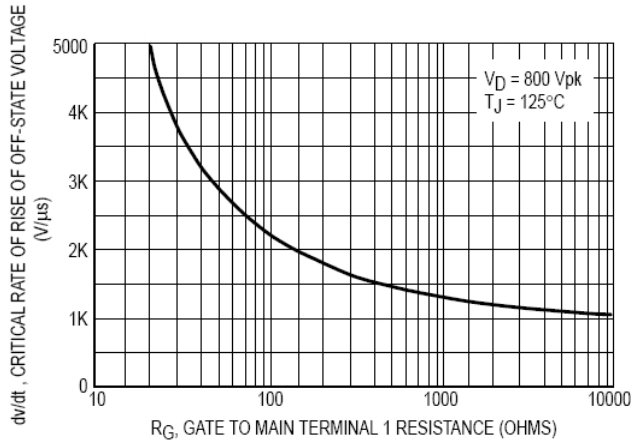


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential)

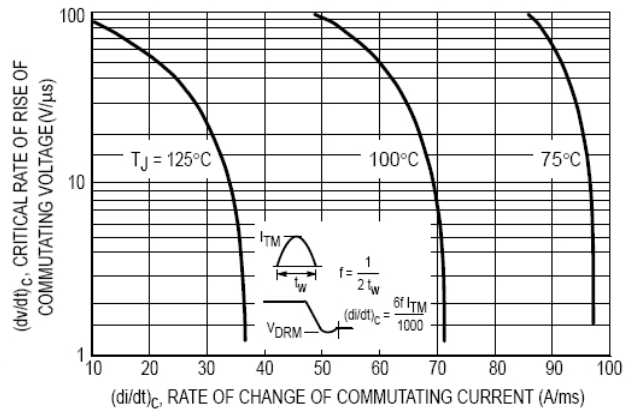
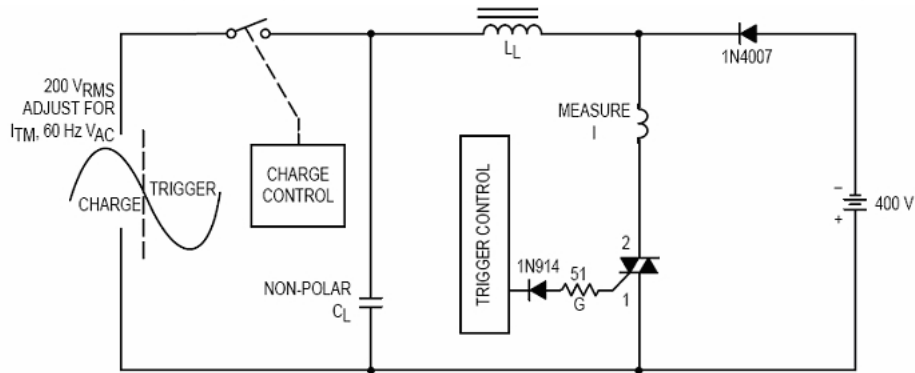


Figure 9. Critical Rate of Rise of Commutating Voltage



Note: Component values are for verification of rated $(dv/dt)_c$.

Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Voltage